

Is Now Part of



ON Semiconductor®

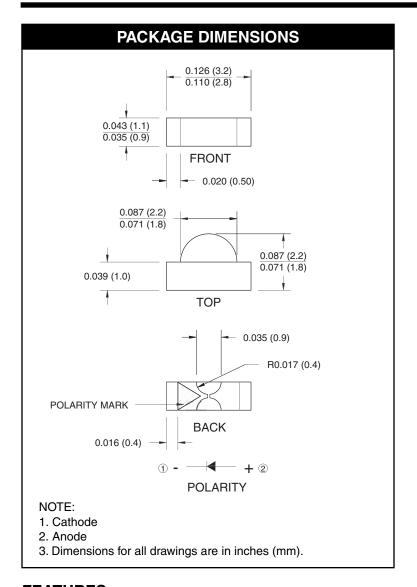
To learn more about ON Semiconductor, please visit our website at www.onsemi.com

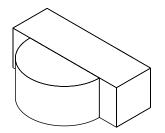
Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild guestions@onsemi.com.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officer



QTLP610CIR





FEATURES

- Right Angle Surface Mount Package
- Available in 0.315" (8mm) width tape on 7" (178mm) diameter reel; 2,000 units per reel
- Wide Viewing Angle 160°
- Wavelength = 940 nm, GaAs
- Water Clear Lens
- Matched Photosensor: QTLP610CPD



QTLP610CIR

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise specified)							
Parameter	Symbol	Rating	Unit				
Operating Temperature	T _{OPR}	-40 to +85	°C				
Storage Temperature	T _{STG}	-40 to +90	°C				
Soldering Temperature (Iron) ^(1,2,3)	T _{SOL-I}	240 for 5 sec	°C				
Soldering Temperature (Flow) ^(1,2)	T _{SOL-F}	260 for 10 sec	°C				
Continuous Forward Current	I _F	65	mA				
Reverse Voltage	V _R	5	V				
Power Dissipation ⁽⁴⁾	P _D	100	mW				
Peak Forward Current (Pulse width = 100µs, Duty Cycle=1%)	I _{FD}	1.0	Α				

Notes:

- 1. RMA flux is recommended.
- 2. Methanol or isopropyl alcohols are recommended as cleaning agents.
- 3. Soldering iron tip at 1/16" (1.6mm) from housing
- 4. At 25°C or below

ELECTRICAL / OPTICAL CHARACTERISTICS (T _A =25°C)								
PARAMETER	TEST CONDITIONS	SYMBOL	MIN.	TYP.	MAX.	UNITS		
Peak Emission Wavelength	I _F = 20 mA	λР	_	940	_	nm		
Emission Angle	I _F = 20 mA	Θ	_	±80	_	Deg.		
Forward Voltage	I _F = 20 mA		_	1.2	1.5			
	$I_F = 100 \text{ mA}, t_P = 100 \mu \text{s}, \text{ Duty Cycle} = 0.01$	V _F	_	1.4	1.85	1 v		
	I _F = 1 A, t _P = 100 μs, Duty Cycle = 0.01		_	2.6	4.0			
Reverse Current	V _R = 5 V	I _R	_	_	10	μA		
Radiant Intensity	I _F = 20 mA		0.5	0.8	_			
	$I_F = 100 \text{ mA}, t_P = 100 \mu \text{s}, \text{ Duty Cycle} = 0.01$	Ee	_	4.0	_	mW/sr		
	I _F = 1 A, t _P = 100 μs, Duty Cycle = 0.01		_	40	_			
Rise Time	I _F = 100 mA	t _r	_	1	_	μs		
Fall Time	t _P = 20 ms	t _f	_	1	_	μs		



QTLP610CIR

TYPICAL PERFORMANCE CURVES

Fig. 1 Forward Current vs.
Ambient Temperature

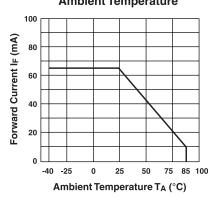


Fig. 2 Relative Radiant Intensity vs. Wavelength

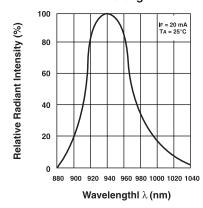


Fig. 3 Peak Emission Wavelength vs.
Ambient Temperature

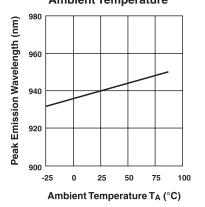


Fig. 4 Forward Current vs. Forward Voltage

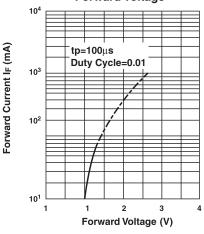


Fig. 5 Relative Intensity vs. Ambient Temperature (°C)

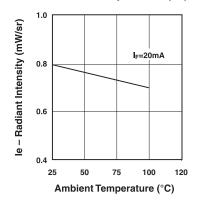
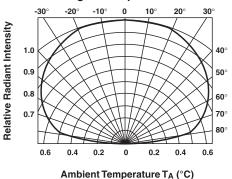


Fig. 6 Relative Radiant Intensity vs.

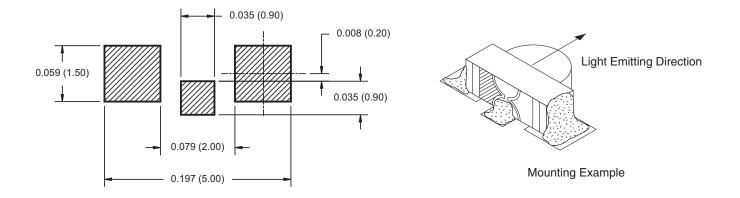
Angular Displacement



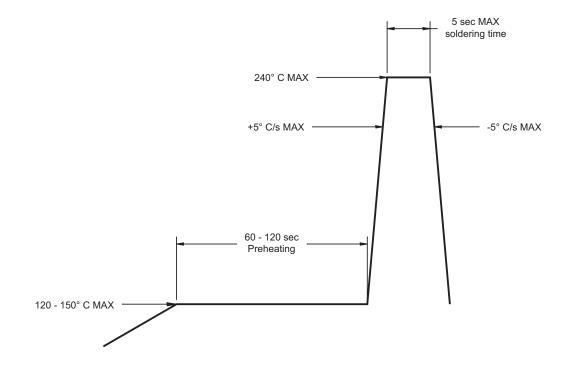


QTLP610CIR

RECOMMENDED PRINTED CIRCUIT BOARD PATTERN



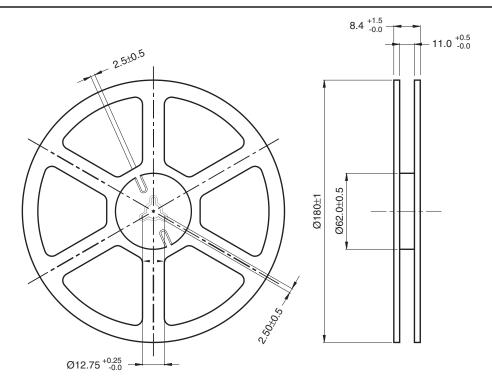
RECOMMENDED IR REFLOW SOLDERING PROFILE

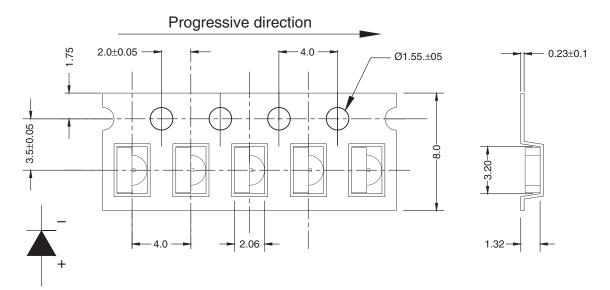




QTLP610CIR

TAPE AND REEL DIMENSIONS





Polarity Dimensional tolerance is \pm 0.1mm unless otherwise specified

Angle: ± 0.5 Unit: mm



QTLP610CIR

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ON Semiconductor and in are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdt/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and exp

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada
Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81–3–5817–1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative